

# RJK03P0DPA

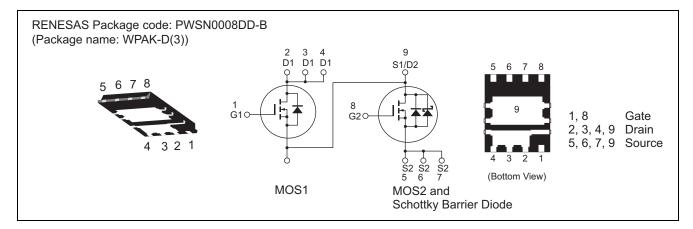
MOS1 30 V, 20 A, 7.0 m $\Omega$  max. MOS2 30 V, 25 A, 7.2 m $\Omega$  max. Built in SBD Dual N-channel Power MOS FET High Speed Power Switching

R07DS0904EJ0120 Rev.1.20 Nov 01, 2012

#### **Features**

- Low on-resistance
- Capable of 4.5 V gate drive
- High density mounting
- Pb-free
- Halogen-free

### **Outline**



# **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

		Ra		
Item	Symbol	MOS1	MOS2	Unit
Drain to source voltage	$V_{DSS}$	30	30	V
Gate to source voltage	$V_{GSS}$	±20	±20	V
Drain current	I <sub>D</sub>	20	25	Α
Drain peak current	I <sub>D(pulse)</sub> Note1	80	100	Α
Reverse drain current	I <sub>DR</sub>	20	25	Α
Avalanche current	I <sub>AP</sub> Note 2	12	9.5	Α
Avalanche energy	E <sub>AR</sub> Note 2	14.4	9.0	mJ
Channel dissipation	Pch Note3	15	20	W
Channel temperature	Tch	150	150	°C
Storage temperature	Tstg	-55 to +150	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

- 2. Value at Tch = 25°C, Rg  $\geq$  50  $\Omega$
- 3. Tc=25°C

# **Electrical Characteristics**

# • MOS1

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	30	_	_	V	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0
Gate to source leak current	I <sub>GSS</sub>	_	_	±0.1	μΑ	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	1	μΑ	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0
Gate to source cutoff voltage	$V_{GS(off)}$	1.2	_	2.5	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Static drain to source on state	R <sub>DS(on)</sub>	_	5.8	7.0	mΩ	I <sub>D</sub> = 10 A, V <sub>GS</sub> = 10 V Note4
resistance	R <sub>DS(on)</sub>	_	8.4	10.9	mΩ	I <sub>D</sub> = 10 A, V <sub>GS</sub> = 4.5 V <sup>Note4</sup>
Forward transfer admittance	y <sub>fs</sub>	_	35		S	I <sub>D</sub> = 10 A, V <sub>DS</sub> = 5 V Note4
Input capacitance	Ciss	_	1180	1650	pF	V <sub>DS</sub> = 10 V
Output capacitance	Coss	_	252		pF	V <sub>GS</sub> = 0
Reverse transfer capacitance	Crss	_	90		pF	f = 1MHz
Gate Resistance	Rg	_	1.0	2.2	Ω	
Total gate charge	Qg	_	7.7		nC	V <sub>DD</sub> = 10 V
Gate to source charge	Qgs	_	3.3		nC	V <sub>GS</sub> = 4.5 V
Gate to drain charge	Qgd	_	2.0		nC	I <sub>D</sub> = 20 A
Turn-on delay time	t <sub>d(on)</sub>	_	7.4		ns	V <sub>GS</sub> =10 V, I <sub>D</sub> = 10 A
Rise time	t <sub>r</sub>	_	4.3	_	ns	V <sub>DD</sub> ≈ 10 V
Turn-off delay time	$t_{d(off)}$	_	34	_	ns	$R_L = 1.0 \Omega$
Fall time	t <sub>f</sub>	_	5.4	_	ns	$R_g = 4.7 \Omega$
Body-drain diode forward voltage	$V_{DF}$	_	0.83	1.08	V	IF = 20 A, V <sub>GS</sub> = 0 Note4
Body–drain diode reverse	t <sub>rr</sub>	_	25	_	ns	IF =20 A, V <sub>GS</sub> = 0
recovery time						di <sub>F</sub> / dt = 100 A/μs

Notes: 4. Pulse test

# • MOS2

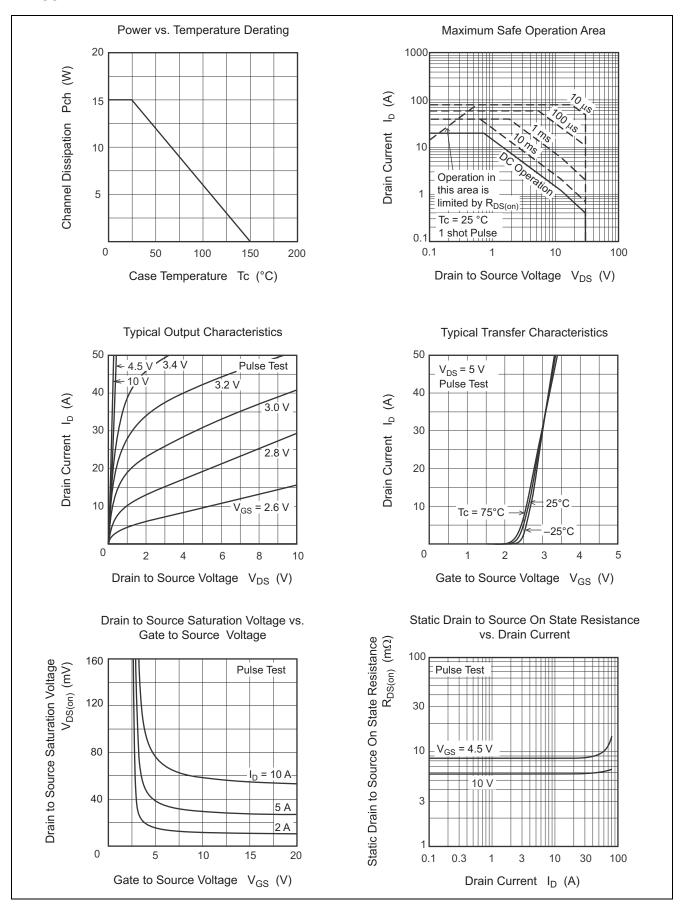
 $(Ta = 25^{\circ}C)$ 

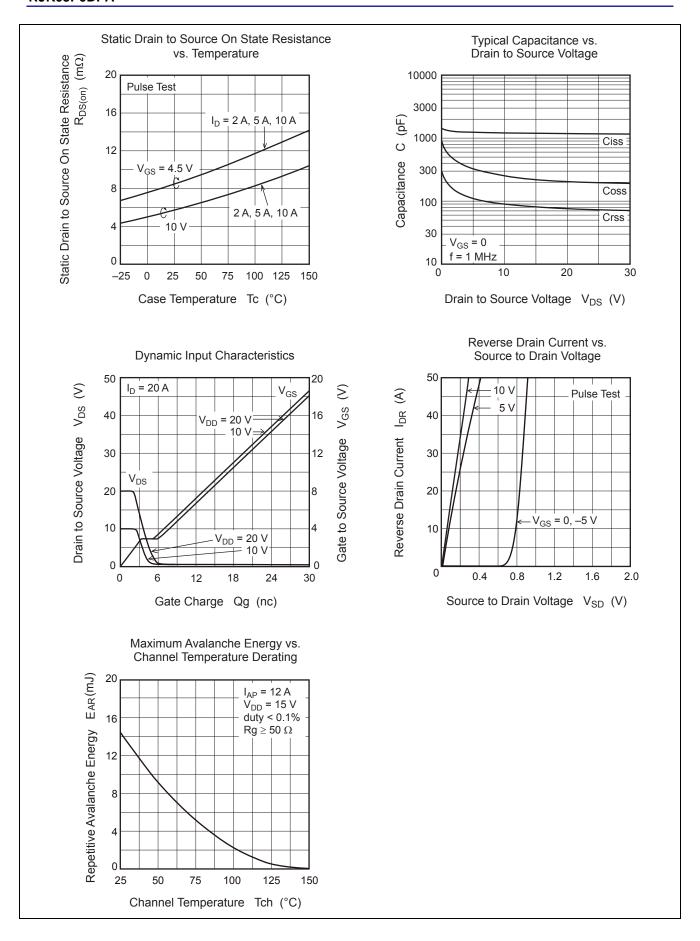
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	30	_	_	V	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0
Gate to source leak current	$I_{GSS}$	_	_	±0.5	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	1	mA	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0
Gate to source cutoff voltage	$V_{GS(off)}$	1.2	_	2.5	V	$V_{DS}$ = 10 V, I $_{D}$ =1 mA
Static drain to source on state	R <sub>DS(on)</sub>	_	6.0	7.2	mΩ	$I_D$ =12.5 A, $V_{GS}$ = 10 V $^{Note4}$
resistance	R <sub>DS(on)</sub>	_	7.2	9.4	mΩ	$I_D = 12.5 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y <sub>fs</sub>		55	_	S	I <sub>D</sub> = 12.5 A, V <sub>DS</sub> = 5 V <sup>Note4</sup>
Input capacitance	Ciss		1900	2660	pF	V <sub>DS</sub> = 10 V
Output capacitance	Coss		360	_	pF	V <sub>GS</sub> = 0
Reverse transfer capacitance	Crss		230	_	pF	f = 1MHz
Gate Resistance	Rg		1.6	3.2	Ω	
Total gate charge	Qg	_	12.3	_	nC	V <sub>DD</sub> = 10 V
Gate to source charge	Qgs	_	4.0	_	nC	V <sub>GS</sub> = 4.5 V
Gate to drain charge	Qgd	_	3.7	_	nC	I <sub>D</sub> = 25 A
Turn-on delay time	t <sub>d(on)</sub>	_	5.2	_	ns	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12.5 A
Rise time	t <sub>r</sub>		3.6	_	ns	V <sub>DD</sub> ≈ 10 V
Turn-off delay time	t <sub>d(off)</sub>		35	_	ns	$R_L = 0.8 \Omega$
Fall time	t <sub>f</sub>	_	12.3	_	ns	$R_g = 4.7 \Omega$
Schottky Barrier diode forward voltage	$V_{F}$	_	0.44	_	V	IF = 2 A, V <sub>GS</sub> = 0 <sup>Note4</sup>
Body-drain diode reverse	t <sub>rr</sub>	_	6.6	_	ns	IF = 25 A, V <sub>GS</sub> = 0
recovery time						di <sub>F</sub> / dt = 100 A/μs

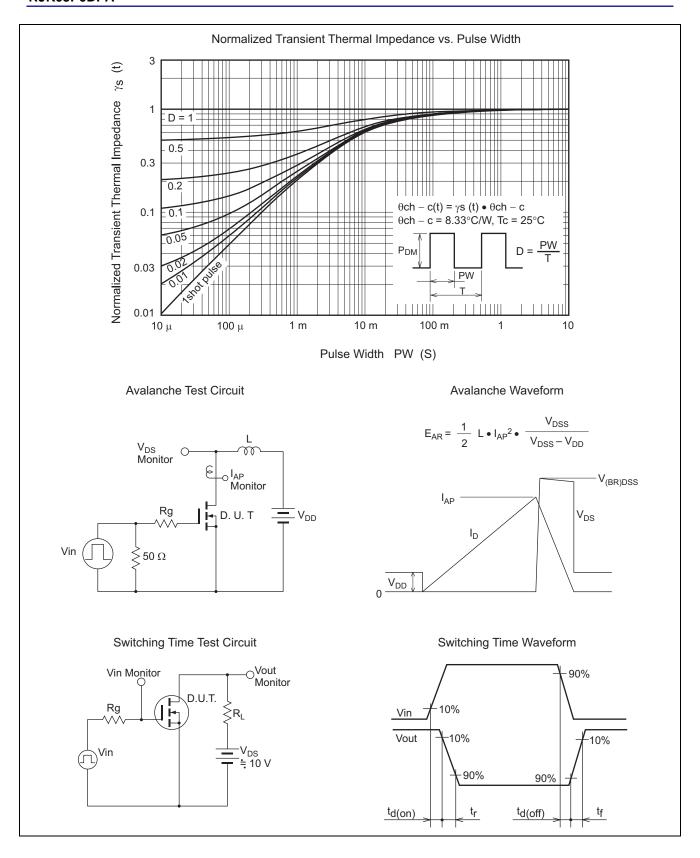
Notes: 4. Pulse

## **Main Characteristics**

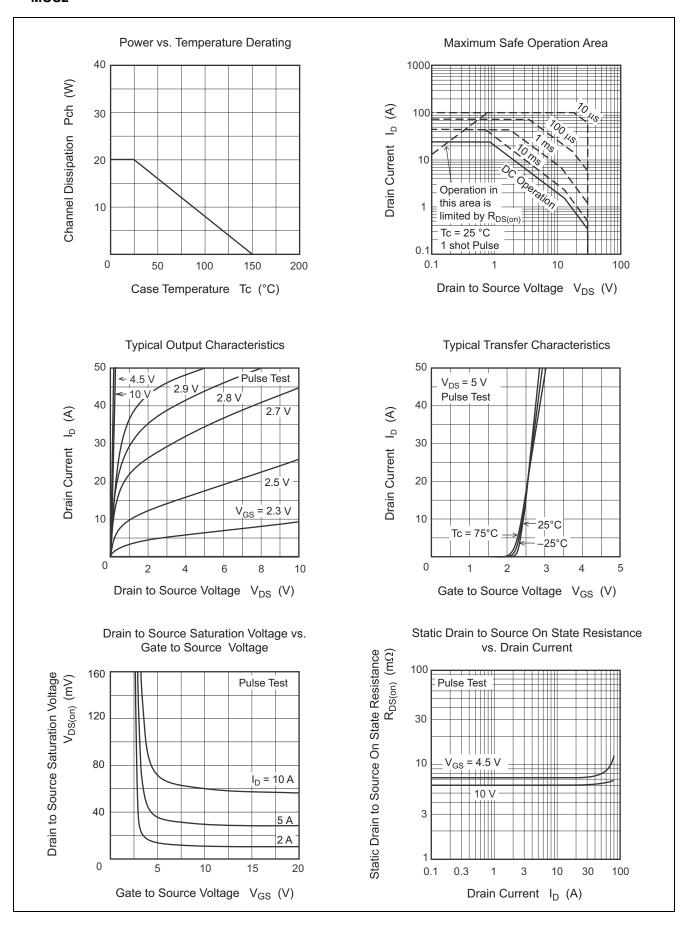
#### • MOS1

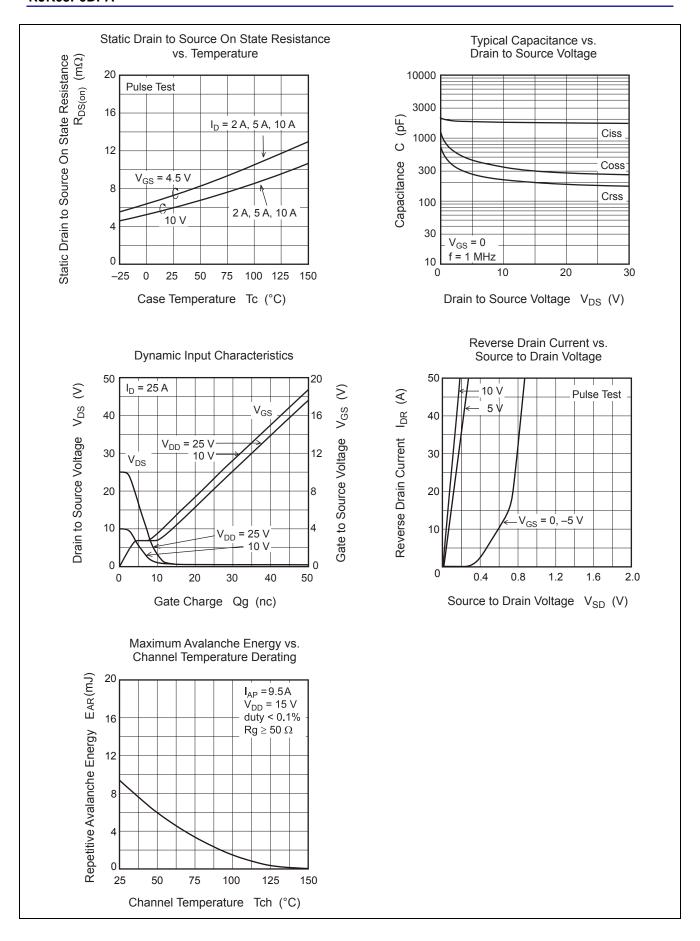


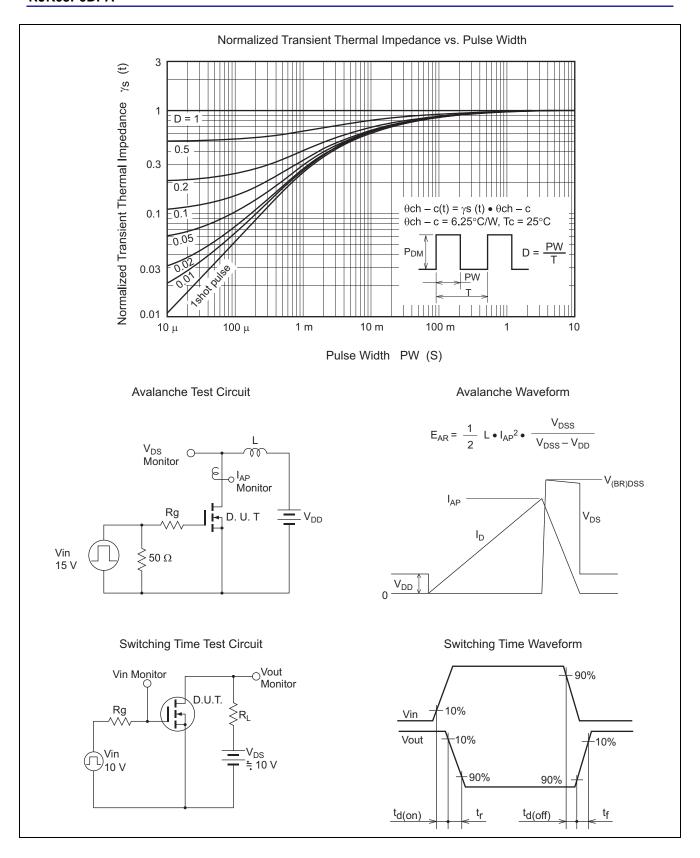




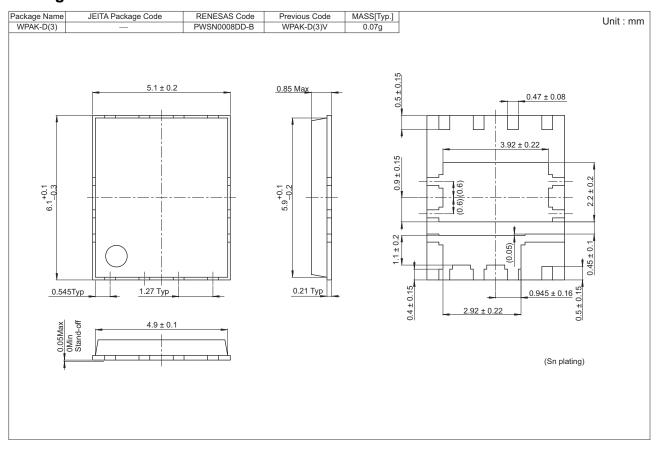
#### • MOS2







# **Package Dimensions**



# **Ordering Information**

Orderable Part Number	Quantity	Shipping Container
RJK03P0DPA-00-J5A	3000 pcs	Taping

Note: The symbol of 2nd "-" is occasionally presented as "#".

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Renesas Electronics America Inc. 2880 Scott Boulevard Santa Clara, CA 95050-2554, U.S.A. Tel: +1-408-588-6000, Fax: +1-408-588-6130

Renesas Electronics Canada Limited 1101 Nicholson Road, Newmarket, Ontario L3Y 9C3, Canada Tel: +1-905-898-5441, Fax: +1-905-898-3220

Renesas Electronics Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K
Tel: +44-1628-651-700, Fax: +44-1628-651-804

Renesas Electronics Europe GmbH

Arcadiastrasse 10, 40472 Düsseldorf, Germany Tel: +49-211-65030, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd. 7th Floor, Quantum Plaza, No.27 ZhiChunLu Ha Tel: +86-10-8235-1155, Fax: +86-10-8235-7679 nunLu Haidian District, Beijing 100083, P.R.China

Renesas Electronics (Shanghai) Co., Ltd.
Unit 204, 205, AZIA Center, No.1233 Lujiazui Ring Rd., Pudong District, Shanghai 200120, China Tel: +86-21-5877-1818, Fax: +86-21-6887-7858 / -7898

Renesas Electronics Hong Kong Limited
Unit 1601-1613, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2868-9318, Fax: +852 2869-9022/9044

Renesas Electronics Taiwan Co., Ltd. 13F, No. 363, Fu Shing North Road, Taipei, Taiwan Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd.
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Tel: +65-6213-0200, Fax: +65-6213-0300

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เกลาเออออ Erectionius เพลาสู่ysta 3นที.bnu. Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

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